

An abstract graphic on the left side of the image, composed of numerous thin, wavy yellow lines that swirl and curve together, creating a sense of movement and depth. The lines are more densely packed in some areas, forming a central vortex-like shape.

Open. Together.



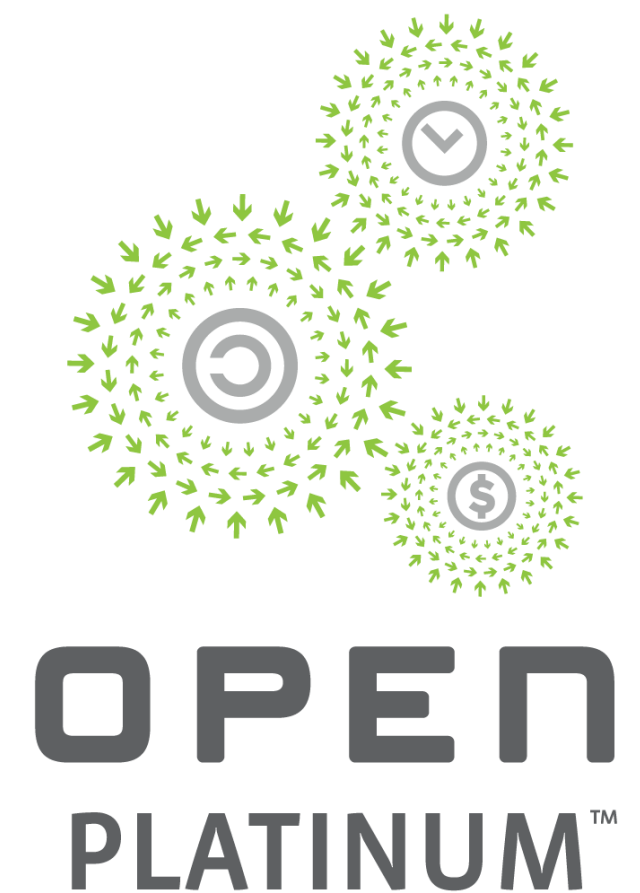
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openEDGE

openEDGE

Chassis form factor development

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openEDGE chassis development



TELCO

2U high open edge chassis addresses the need for even more compact edge deployments where number of servers needed is between 1 to 3 server sleds.

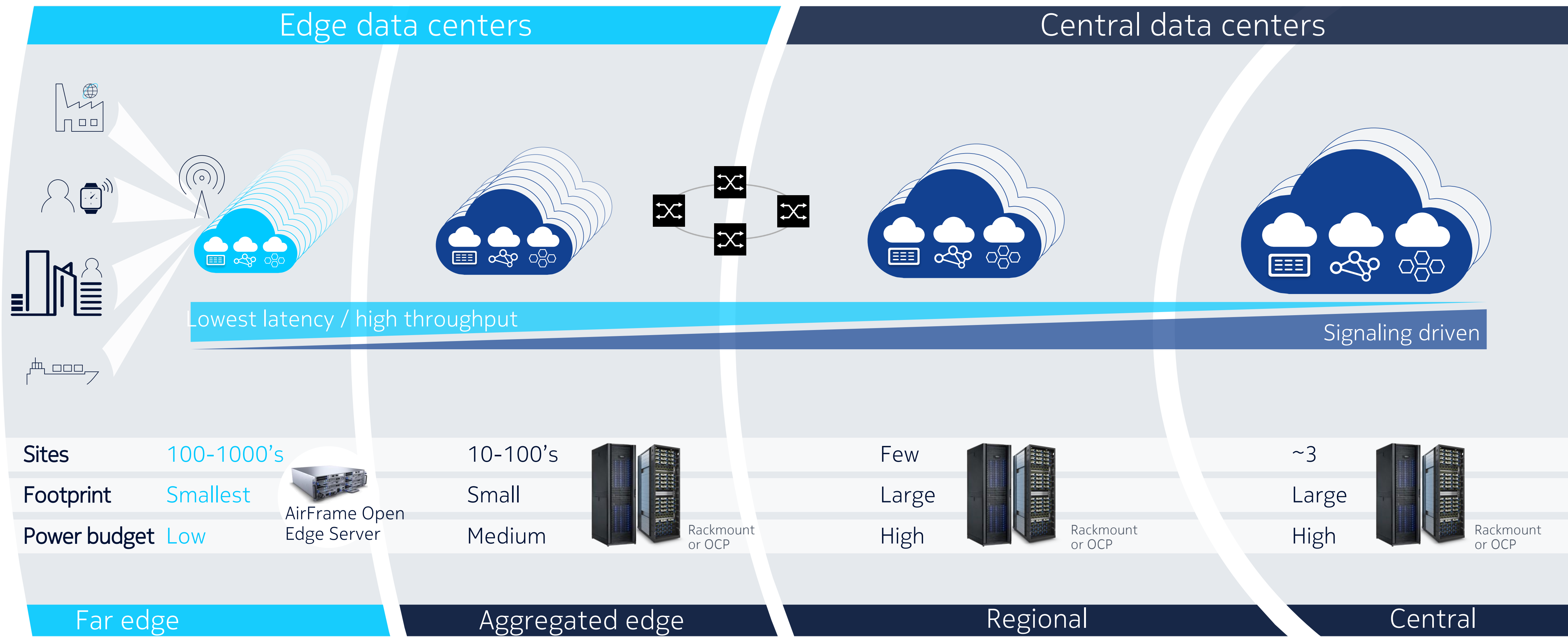
The chassis supports the same server designs as the already introduced 3U high open edge chassis, including the same power supplies and RMC module.



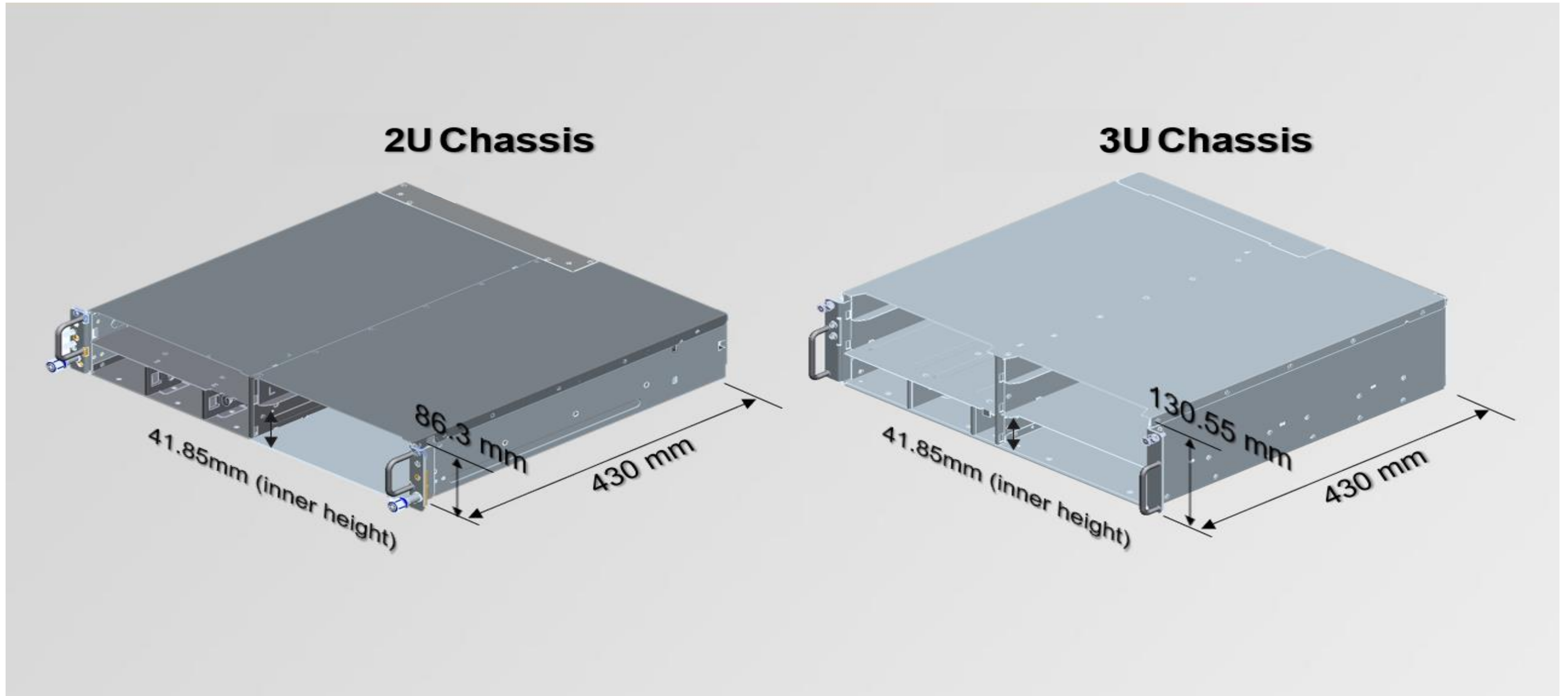
Product
Recognition

Managing the lowest latency/cost trade off with a layered architecture

First data center solution designed for the edge



2U chassis meets the requirements for smaller footprint installations



Open edge 2U chassis

Maintaining full compatibility with sleds designed for 3U chassis



- Chassis height 86,3mm
- Fully backwards compatible with 1U and 2U sleds
- Uses same AC and DC power supplies with 3U chassis
- Same RMC for both 2U and 3U chassis form factors
- Same power feed capacity per sled as with 3U chassis
- Same environmentals supported as with 3U chassis



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Open edge chassis future development options

Topics for discussion – opportunities for ecosystem collaboration

- Full width sled support
- 3U sled support
- 5U chassis
- Switch development – half width, full width
- BBU needs – capacity, back-up time etc
- HW acceleration sled – FPGA, GPU
- Storage sled
- Micro-server sled with Intel Atom technology, 3U

Product Info

- 3U open edge chassis is "OCP Accepted"
- Process for achieving "OCP Accepted" for 2U chassis has been started
- Visit Nokia booth to see the 2U Chassis!

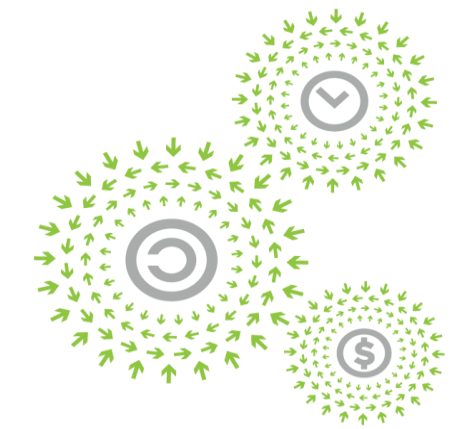
<https://www.opencompute.org/products/324/nokia-openedge-chassis>



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Call to Action

- Join the dialogue in the open edge subproject calls!
- Nokia plans to contribute the 2U chassis design as “OCP Accepted” by end of 2019

Where to buy: <https://www.opencompute.org/products/324/nokia-openedge-chassis>

Project Wiki with latest specification : <https://www.opencompute.org/wiki/Telcos/openEDGE>

Mailing list: <https://ocp-all.groups.io/g/OCP-Open-Edge>



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OCP Regional Summit
26–27, September, 2019